

HIGH APPARENT CREEP ACTIVATION ENERGIES IN MUSHY ZONE MICROSTRUCTURES

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> (Received December 21, 1993) (Revised May 16, 1994)

1. Mechanical data characterizing mushy zone microstructures

Modelling represents an important tool in modern material processing which no longer follows the traditional trial and error route but rather represents what may be termed a right first time technology [1]. To successfully model technological solidification processes, thermodynamic and kinetic data are required. But mechanical aspects are important as well [2]: during solidification, temperature gradients or mechanical constraints imposed by the mold result in solidification stresses. These stresses must be considered for at least the following two reasons: first, they can lead to local air gap formation between metal and mold thus changing heat extraction, cooling rate and finally the cast microstructure [3]; second, at a larger scale they may influence the final product shape [4]. Moreover, they can assist in cavity formation and can produce cracking. Such stresses become important as soon as a significant amount of solid phase has formed during solidification. In principle, these stresses can be calculated using viscoelastic finite element stress analysis [5]. But, finite element calculations require as an input the constitutive law which governs the mechanical behavior. Therefore, there is an interest in mechanical data of solidifying alloys with mushy zone microstructures: Ackermann and Kurz [6] investigated the mechanical properties of a solidifying Al-Mg alloy perpendicular to the growth axis of the columnar crystals. The tensile behavior of solidifying Al-Cu alloys was studied by Wisniewski [7] and recently, Branswyck [8] proposed a modified indentation test which, in combination with FEM analysis, yields quantitative flow rules. Nevertheless, there is still a need for more mechanical data of solidifying alloys, especially creep data - where strain accumulates at a constant stress - only rarely exist for processing conditions.

Creep data are generally available for temperatures far below the melting point. One way of obtaining input data for process modelling is to use constitutive equations established on the basis of low temperature data and extrapolate to solidification temperatures. For creep one can use the well established equation for the minimum creep rate

$$\varepsilon_{\text{min}} = A \cdot \sigma^{n} \cdot \exp\left(-\frac{Q}{R \cdot T}\right) \tag{1},$$

where A is a constant, Emin is the minimum creep rate, Q represents the apparent creep activation energy and R and T are universal gas constant and temperature, respectively. However, mechanical data which are obtained by such an extrapolation do not appropriately reflect the mechanical behavior of mushy zone microstructures [9]. In this work, we present creep data for mushy zone microstructures of aluminum alloys. In the evaluation of the creep data, we focus on the temperature dependence of the minimum creep rate.

2. Material, experiments and mechanical results

The chemical composition of the two aluminum alloys investigated in the present study (referred to as AA1201 and AA3104) are given in Table 1. Large ingots were cast using these grain-refined alloys in a direct chill continuous casting ('DCC') process [10]. From these alloys, standard creep specimens with a 40 mm gauge length and a 8 mm diameter were machined and tested at constant

load in high resolution creep machines at temperatures ranging from 300° to 645°C, and at stresses between 0.25 and 30 MPa. The objective of this work was to obtain mechanical data which could be used as an input for FEM calculations of stresses and strains in the DCC process.

Alloy/Element	Fe	Si	Mg	Min
AA1201	0.41	0.14	0.012	0.018
AA3104	0.46	0.22	1.14	1.04

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Table 1: Composition (% wt) of the two aluminum alloys investigated in the present study.

Figures 1a and 1b show creep results obtained for alloy AA1201 at 640°C. From such tests, the stress dependence of the minimum creep rate was determined as shown in Figures 2a and 2b for alloys AA1201 and AA3104, respectively. The stress exponent n decreases with increasing temperature for both alloys. Figures 3a and 3b show the temperature dependence of the minimum creep rates for alloys AA1201 and AA3104, respectively; the values of creep rates at low temperatures were obtained by extrapolation from higher stress data. For both alloys, the apparent activation energies for creep increase with increasing temperature. It is striking that for alloy AA1201 the measured apparent creep activation energy increases rapidly with temperature above 620°C. For alloy AA3104, the apparent activation energy increases from 800 kJ/mol below 600°C to 2525 kJ/mol above this temperature. These values are much higher than activation energy values which can be rationalized on the basis of diffusion assisted climb processes which control creep of pure metals and single phase alloys [11-13].

Figure 4 shows the microstructure of alloy AA3104 after creep testing at 625°C and waterquenching. The former liquid phase transforms into a fine eutectic microstructure which appears between the primary phase dendrites.

3. Rationalization of high apparent creep activation energies

A hypothetical binary phase diagram: In order to explain the high apparent creep activation energies (Figure 3), we consider a simple binary eutectic system which is shown in Figure 5. The coordinates of this diagram are given in Table 2. In this phase diagram, we consider three values of concentration: c_a (2.4%) which is far from the eutectic concentration, c_c (11.5%) which is near the eutectic concentration and c_b (8.5%). These three concentrations will allow us to consider the influence of the alloy composition on creep behavior with special emphasis placed on the role of the part of the microstructure which is eutectic.

coordinate	temperature / °C	concentration / %
melting point of pure A	650 (T _m)	0
maximum solubility of B in A	600 (T _e)	4 (c ₁)
eutectic reaction	600 (T _e)	15 (c ₂)

Table 2: Coordinates of the hypothetical binary system schematically illustrated in Figure 5.

<u>Calculation of the amount of solid phase in the solid/liquid-region</u> [14]: Under thermodynamic equilibrium, the relative amount of the solid phase - $f_S(T)$ - in the solid-liquid region, is given by the lever rule

$$f_s(T) = \frac{1}{1-k} \cdot \frac{(T_{11qu} - T)}{(T_m - T)}$$
 (2),

where T_{liqu} represents the concentration-dependent liquidus temperature, T_m is the melting point of pure A and k is the distribution coefficient which is obtained as the ratio between the solid concentration c_S and the liquid concentration c_I [15]. For the binary diagram schematically illustrated in Figure 5, the equilibrium value of this distribution coefficient was 0.27.

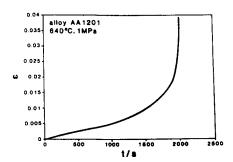


Figure 1a: Creep strain as a function of time for alloy AA1201 (640°C, 1MPa).

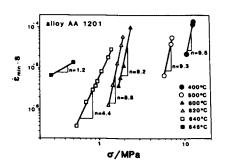
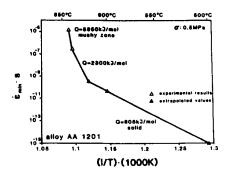


Figure 2a: Stress dependence of minimum creep rate for alloy AA1201.



<u>Figure 3a:</u> Temperature dependence of minimum creep rate (AA1201).

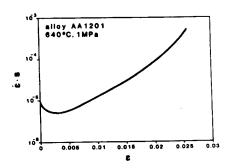
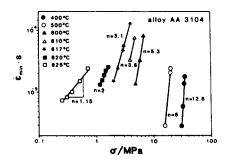
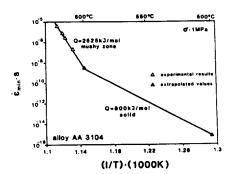


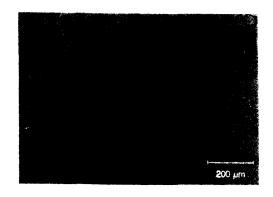
Figure 1b: Creep rate as a function of strain for alloy AA1201 (640°C, 1MPa).



<u>Figure 2b</u>; Stress dependence of minimum creep rate for alloy AA3104.



<u>Figure 3b:</u> Temperature dependence of minimum creep rate (AA3104).



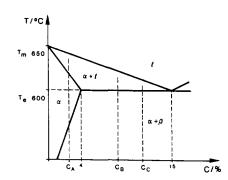
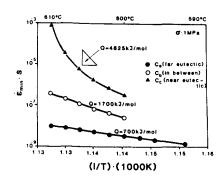


Figure 4: Two phase microstructure of alloy AA3104 after quenching from 625°C.

Figure 5: Hypothetical binary phase diagram.



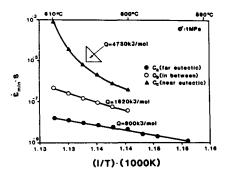


Figure 6a: Temperature dependence of the minimum creep rate for c_A , c_B and c_C . $f_S(T)$ values from Equation 2.

Figure 6b: Temperature dependence of the minimum creep rate for c_A , c_B and c_C . $f_S(T)$ values from Equation 3.

The results presented in Figures 6a and 6b clearly show that mechanical data for mushy zone microstructures with a low volume fraction of liquid phase can not be obtained by simply extrapolating lower temperature solid state data. Based on a simple solid-liquid model of the mushy zone microstructure, unusually high values of apparent creep activation energies can be rationalised. Activation energy values depend on (i) the phase diagram, (ii) the temperature, (iii) the alloy composition and (iv) on whether or not non-equilibrium phases are present. The results obtained using the simplified model outlined above are in good qualitative agreement with the experimental data, Figures 3a and 3b.

4. Discussion, summary and conclusions

In the present work, creep data for mushy zone microstructures with a large fraction of solid phase are reported. Very high values of apparent creep activation energies were observed (Figures 3a and 3b). A simple solid-liquid model was proposed in which the relative amount of solid - which carries all of the load - depends on the solidification conditions and is given by the lever rule (Equation 2) or the Scheil model (Equation 3). This model can help to explain the extremely high values of apparent creep activation energies in mushy zone microstructures. Straub and Blum do not observe such high values of apparent creep activation energies in single phase high purity aluminum

The microstructure of an alloy with a concentration smaller than the eutectic concentration but larger than the maximium solubility of B in A consists of α -phase particles surrounded by α/β -eutectic. When heating such an alloy above T_{α} , the eutectic regions will melt.

During casting, diffusion is generally not fast enough to establish equilibrium conditions in a relatively short period and thus Equation 2 should not be applied. A better description of the amount of solid phase in the two phase region was proposed by Scheil [16] for the case of a solidifying alloy:

$$f_s(T) = 1 - \left(\frac{T_m - T}{T_m - T_{liqu}}\right)^{\frac{1}{k-1}}$$
 (3).

Equation 3 allows for the formation of eutectic microstructure even for alloy concentrations like c_A (Figure 5), which are lower than the maximum solubility of B in A (Table 2). During creep, this eutectic regions will transform into liquid phase at temperatures above T_B .

A simplified model of creep in mushy zone microstructures: We now introduce a simple solid-liquid model of the mushy zone microstructure for low volume fractions of liquid. In this model, the liquid part of the mushy zone microstructure fully unloads and stresses are transferred to the remaining solid. The load carrying cross section perpendicular to the direction of the applied stress is given by $S_O \cdot f_S(T)$, where S_O is the cross section of the entire sample and $f_S(T)$ is the volume fraction of solid given either by Equation 2 (thermodynamic equilibrium) or by Equation 3 (Scheil approach). The load carrying cross section decreases as the amount of liquid in the two phase region increases. It is now assumed that solid state creep does not depend on concentration, i.e. at temperatures below T_O the three alloy compositions, C_O and C_O , show the same creep behavior. This creep behavior is represented by Equation 1 using the set of parameters A, B and B0 which is given in Table 3.

creep parameters	value	
A [MPa ⁻⁴ /s]	2.3 . 1033	
n	4	
Q [kJ/mol]	700	

Table 3: Creep parameters used in the calculations for solid state creep.

During creep above the eutectic temperature, the mushy zone microstructure forms and the solid cross section decreases. The creep rate is then obtained as

$$\varepsilon_{\min} = A \cdot \left(\frac{\sigma_0}{f_s(T)}\right)^n \cdot \exp\left(-\frac{Q}{R \cdot T}\right)$$
 (4),

 $\sigma_{\rm O}$ is the applied stress which was chosen as 1 MPa in our calculations. In a first step, minimum creep rates where calculated from Equation 4 using an equilibrium $f_{\rm S}(T)$ -value, Figure 6a. It can be clearly seen that the apparent creep activation energy for the mushy zone microstructure is much higher than the apparent creep activation energy in the solid state. This apparent activation energy increases with temperature and its value is strongly dependant on alloy composition. At composition $c_{\rm A}$ the alloy is solid at temperatures just above $T_{\rm B}$ and the apparent creep activation energy does not depend on temperature below $T_{\rm B}$. For alloy compositions $c_{\rm B}$ and $c_{\rm C}$, significantly higher apparent creep activation energies are obtained at temperatures just above $T_{\rm B}$; this is simply due to the fact that parts of the alloys are now liquid and do not carry load.

For the low concentration alloy (composition c_A), this effect is even more pronounced when using the more realistic $f_S(T)$ -values defined by Equation 3, Figure 6b. In this case, the alloy of composition c_A contains a fraction of eutectic phase that melts at T_{θ} . Thus, the solid fraction is less than one at temperatures just above T_{θ} - contrary to the equilibrium case (Equation 2) - and the apparent creep energy is higher (900 kJ/mol in this case against 700 kJ/mol in the equilibrium case). For higher concentrations, Scheil's correction does not significantly influence the results.

tested in the same temperature range [11]. In binary eutectic alloys, the large increase in apparent creep activation energy at temperatures just above the eutectic temperature is mainly due to the fact that in the solid-liquid region the area of the load carrying solid cross section decreases.

Modelling results are in good qualitative agreement with the experimental data, Figures 3a and 3b for the two aluminum alloys AA1201 and AA3104. Reality is probably more complex. Thus it must be expected, that even before significant parts of the solid melt, the rate of grain boundary sliding will have increased greatly, possibly due to the formation of a liquid grain boundary phase. Enhanced creep rates in the solid-liquid region can be explained by the fact that the liquid may act as a lubricant allowing the grains of the materials to slide over each other more easily, or, that the liquid may provide a high diffusivity path, allowing diffusional transport away from load-bearing points or surfaces, very much as grain-boundary diffusion does during Coble creep. This is in agreement with the low stress exponent which is found just below the eutectic temperature (Figures 2a and 2b). Pharr and Ashby [17] proposed a coupled-plasticity-plus-dissolution model in which the role of the liquid was to reduce the section of the necks, by dissolution, until the local stress there became large enough to cause another increment of plasticity or creep. It is believed that such a more realistic microstructural scenario - while much more difficult to model - will influence the apparent creep activation energy in a similar way, as the simple solid-liquid model outlined above.

Acknowledgement

Financial support by Alusuisse and the Swiss government under contract CERS 2496 is greatfully acknowledged. The authors wish to thank P. Musso for his help with the creep testing.

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